

3.0x2.0mm SURFACE MOUNT LED LAMP

Hyper Red Part Number: KA-3021SURCKT

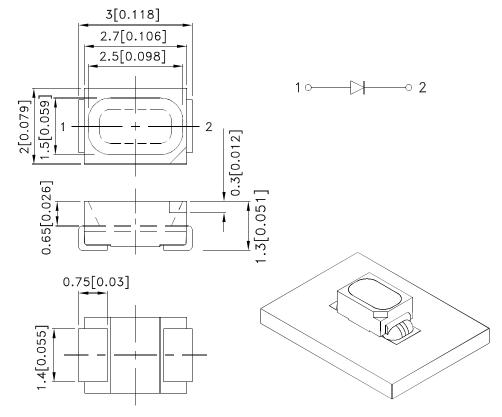
Features

- 3.0mm x 2.0mm, 1.3mm high, only minimum space required.
- Suitable for compact optoelectronic applications.
- Low power consumption.
- Package: 2000pcs / reel.
- Moisture sensitivity level : level 4.
- RoHS compliant.

Description

The Hyper Red source color devices are made with AlGaInP on GaAs substrate Light Emitting Diode.

Package Dimensions



SPEC NO: DSAK0990

APPROVED: WYNEC

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is $\pm 0.2(0.008")$ unless otherwise noted.
- The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
 The device has a single mounting surface. The device must be mounted according to the specifications.

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Selection Guide

Part No.	Dice	lv (mcd) [2] Dice Lens Type @ 20mA		,	Viewing Angle [1]
		2.	Min.	Тур.	201/2
KA-3021SURCKT	Hyper Red (AlGaInP)	WATER CLEAR	70	200	125°

- 1. θ1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value. 2. Luminous intensity/ luminous Flux: +/-15%.

Electrical / Optical Characteristics at TA=25°C

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Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions		
λpeak	Peak Wavelength	Hyper Red	650		nm	IF=20mA		
λD [1]	Dominant Wavelength	Hyper Red	630		nm	IF=20mA		
Δλ1/2	Spectral Line Half-width	Hyper Red	28		nm	IF=20mA		
С	Capacitance	Hyper Red	35		pF	V _F =0V;f=1MHz		
VF [2]	Forward Voltage	Hyper Red	1.95	2.5	V	IF=20mA		
lr	Reverse Current	Hyper Red		10	uA	V _R =5V		

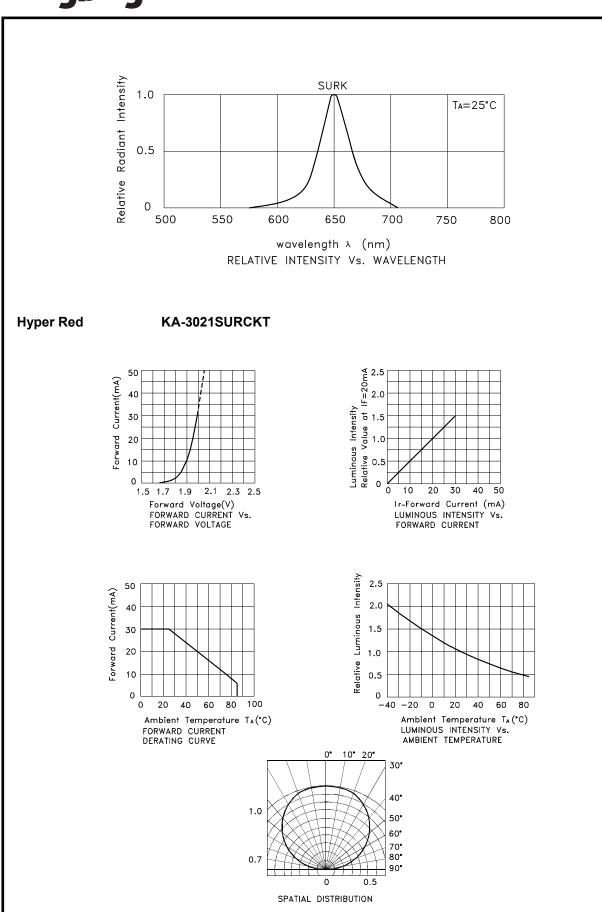
- 1.Wavelength: +/-1nm.
- 2. Forward Voltage: +/-0.1V.

Absolute Maximum Ratings at TA=25°C

Parameter	Hyper Red		
Power dissipation	75	mW	
DC Forward Current	30	mA	
Peak Forward Current [1]	185	mA	
Reverse Voltage	5	V	
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

Note: 1. 1/10 Duty Cycle, 0.1ms Pulse Width.

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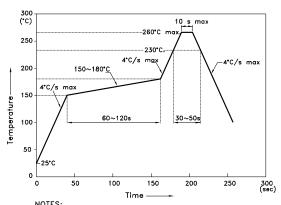
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Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



NOTES:

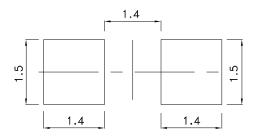
1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

2.Don't cause stress to the epoxy resin while it is exposed to high temperature.

to high temperature.

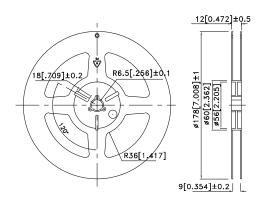
3.Number of reflow process shall be 2 times or less.

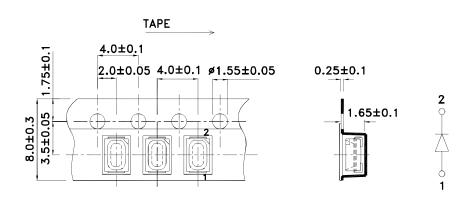
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



Tape Dimensions (Units : mm)

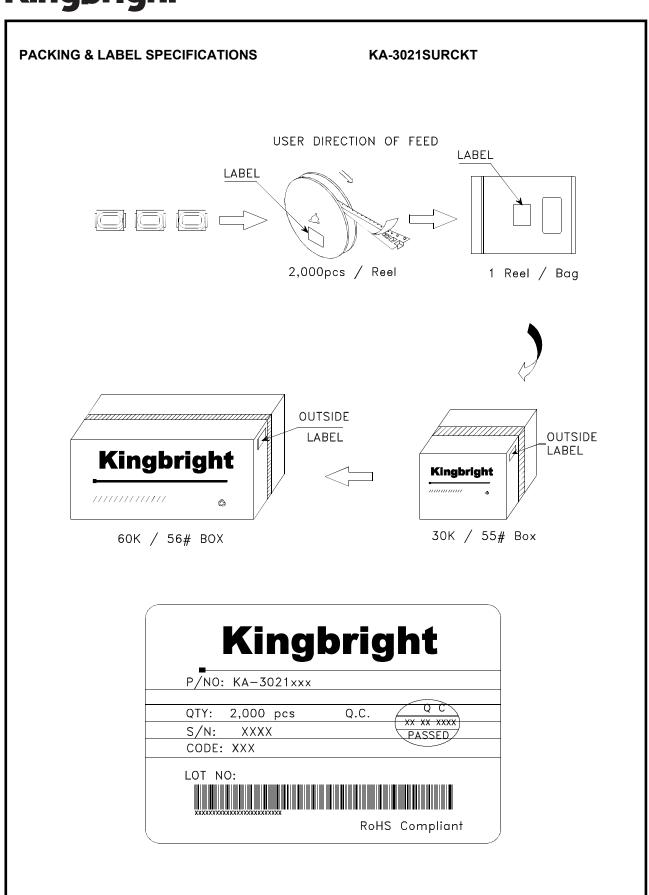
Reel Dimension





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